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Rev. 3-21-01

Effective March 1998

REISSUE DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

☐ Original ☐ Supplemental ☒ Substitute ☐ PCT ☐ DESIGN

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; that I verily believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Title: MOISTURE CURABLE COMPOSITION

of which is described and claimed in:

☐ the attached specification, or

☐ the specification in application Serial No. _____, filed _____, and with amendments through _____

☐ the specification in International Application No. _____, filed _____, and as amended on _____ (if applicable) or

☒ U.S. patent number 6,306,966 granted on October 23, 2001 and in the attached specification for which I solicit a reissue patent.

I hereby state that I have reviewed and understand the content of the above-identified specification, including the claims, as amended by any amendment(s) referred to above.

I acknowledge my duty to disclose to the Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I hereby claim priority benefits under Title 35, United States Code, §119 (and §172 if this application is for a Design) of any application(s) for patent or inventor's certificate listed below and have also identified below any application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

COUNTRY	APPLICATION NO.	DATE OF FILING	PRIORITY CLAIMED

I verily believe that the above original patent is partly inoperative by reason of claiming more or less than I had a right to claim.

A Statement of Error

The patent claims are erroneously limited to polymethyl methacrylate powder as component B. In the prosecution of the original Patent No. 6,306,966, an important and indispensable material, that is, amorphous silica was cancelled due to miscommunication between the Japanese patent firm and the applicant, so the new claims recite amorphous silica. As the Reissue Application is to broaden the original claims, it is timely filed within two years of the issue date, that is, on October 23, 2003.

All errors corrected in this reissue application up to the time of filing of this oath/declaration arose without any deceptive intention on the part of the applicant.

I hereby claim the benefit under Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code §112, I acknowledge the duty to disclose information material to patentability as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

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And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cherk, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; Michael S. Hopper, Reg. No. 40,268 and Jeffrey R. Filipek, Reg. No. 41,471, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected herewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from ISHIHARA & COMPANY as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

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I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

1st Inventor Yasunobu Horie Date October 25, 2006
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6th Inventor Hiroshi Aoki Date October 25, 2006
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The above application may be more particularly identified as follows:

U.S. Application Serial No. 10/691,433 Filing Date October 23, 2003

Applicant Reference Number 75543-P-US Any Docket No. 2003-1406

Title of Invention MOISTURE CURABLE COMPOSITION